## CUSTOMER DRAWING



| Product Name | Product Dimensions |  |  | Cable Dimensions |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | L | $\emptyset \mathrm{A}$ | $\emptyset \mathrm{B}$ | $\emptyset \mathrm{D}$ | $\emptyset \mathrm{E}$ | $\mathrm{J} \pm 0.5$ | $\mathrm{M} \pm 0.5$ |
|  | $\max$ | $\min$ | $\min$ | $\max$ | $\min$ | $(\mathrm{~J} \pm 0.02)$ | $(\mathrm{M} \pm 0.02)$ |
| $\mathrm{D}-104-31$ | 29.75 | 10.80 | 11.65 | 11.43 | 5.70 | 8 | 9 |
|  | $(1.170)$ | $(0.425)$ | $(0.460)$ | $(0.450)$ | $(0.225)$ | $(0.315)$ | $(0.355)$ |

## MATERIALS

1. INSULATION SLEEVE: Heat-shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
2. SOLDER PREFORM WITH FLUX:

SOLDER: TYPE Sn63 per ANSI-J-STD-006.
FLUX: TYPE ROM1 per ANSI-J-STD-004.
3. MELTABLE RING: Thermally stabilized thermoplastic. Color: blue.
4. MELTABLE RING: Thermally stabilized thermoplastic. Color: natural.

## APPLICATION

1. This part is designed to provide an environment protected shield termination on cables, rated for $125^{\circ} \mathrm{C}$ minimum, meeting the dimensional criteria listed, having nickel plated copper shields.
2. Install using TE Connectivity approved convection or infrared tools in accordance with Raychem assembly procedure RCPS-100-70.
3. Assemblies will meet requirements of Raychem specification RT-1404 and National Aerospace Standard NAS-1747.
4. Temperature range: $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$.

For best results, prepare the cable as shown:


| c |  |  | Raychem THERMOFIT DEVICES | SOLDERSLEEVE* SHIELD TERMINATOR |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets] |  |  |  | DOCUMENT NO.: $\quad$ D-104-31 |  |  |
| $\begin{aligned} & \hline \text { TOLERANCES: } \\ & 0.00 \mathrm{~N} / \mathrm{A} \\ & 0.0 \mathrm{~N} / \mathrm{A} \\ & 0 \mathrm{~N} / \mathrm{A} \\ & \hline \end{aligned}$ | ANGLES: N/A ROUGHNESS IN MICRON |  | TE Connectivity reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application. | REV : |  | -APR-2020 |
| DRAWN BY: M. FORON |  | $\begin{aligned} & \hline \text { DATE: } \\ & \text { 22-MAR-99 } \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline \text { ECO: } \\ & \text { ECO-20-005247 } \end{aligned}$ | $\begin{array}{ll} \hline \text { SCALE: } & \\ & \text { NTS } \end{array}$ | $\begin{array}{r} \hline \text { SIZE: } \\ \text { A } \end{array}$ | SHEET: <br> 1 of 1 |

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